



64,600-095; ERSO 900038; Serial Number 10 057,009

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

TO: ASSISTANT COMMISSIONER FOR PATENTS
Washington, D.C. 20231

FROM: Tung & Associates
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Bloomfield Hills, MI 48302

DATE: 8 April 2003

REF: Applicant : Chen et al. Filing Date : 24 January 2002
Serial No : 10/057,009 Att'y No. : 64,600-095
Art Unit : 2818 Examiner : Quoc Dinh Hoang
Title : Micro Fabrication With Vortex Shaped Spirally Topographically
Tapered Spirally Patterned Conductor Layer and Method for
Fabrication Thereof

RESPONSE TO OFFICE ACTION

Sir:

In response to an office action mailed on 27 January 2003, please consider the following remarks pertaining to the above referenced application. There are no amendments to the specification, claims or drawings. A listing of the claims begins on page 2. Remarks begin on page 5.

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to the Assistant Commissioner for Patents, Washington D.C., 20231 on Apr. 10 2003.

Kathy Dixon